

# RV1S2951A

LOW FORWARD-CURRENT(IF), OPERATING AMBIENT TEMPERATURE 115 °C, 4-PIN ULTRA SMALL PACKAGE FLAT-LEAD PHOTOCOUPLER

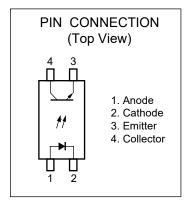
R08DS0288EJ0100 Rev.1.00 Jun. 20, 2024

#### DESCRIPTION

The RV1S2951A is an optically coupled transistor-output isolator featuring the high current transfer ratio at a sub-mA of the forward current. The RV1S2951A consists of an AlGaAs LED on the input side and an NPN silicon phototransistor on the output side in an ultra-small flat-lead package to reduce the mounting area by 30 % compared with the SSOP for PS28xx series keeping 4 mm creepage distance.

### **FEATURES**

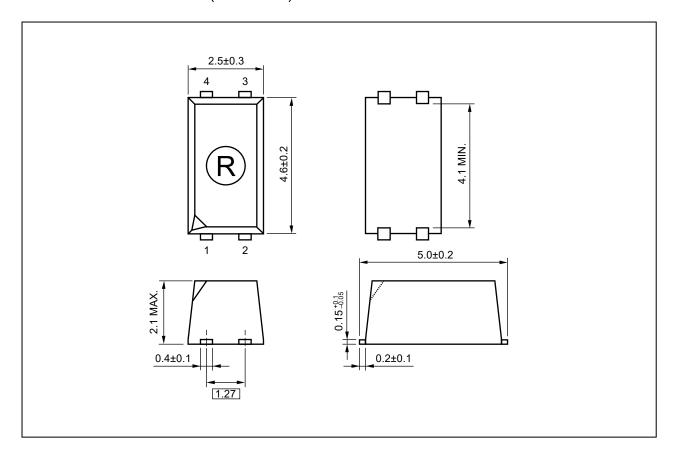
- Ultra small flat-lead package (4.6 (W) × 2.5 (L) × 2.1 (H) mm)
- High current transfer ratio (CTR = 300 % MIN. @ I<sub>F</sub> = 50 μA)
- Operating ambient temperature (115 °C MAX.)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Embossed tape product: RV1S2951ACCNS-1F0x#KC0: 3 500 pcs/reel
- Pb-free product
- Safety standard
  - UL : UL1577, Single protection
  - CSA: CAN/CSA-C22.2 No.62368-1, Reinforced insulation
  - VDE: DIN EN IEC 60747-5-5 (Option)



### **APPLICATIONS**

- Air conditioner
- Measurement equipment
- Power supply

# PACKAGE DIMENSIONS (UNIT: mm)

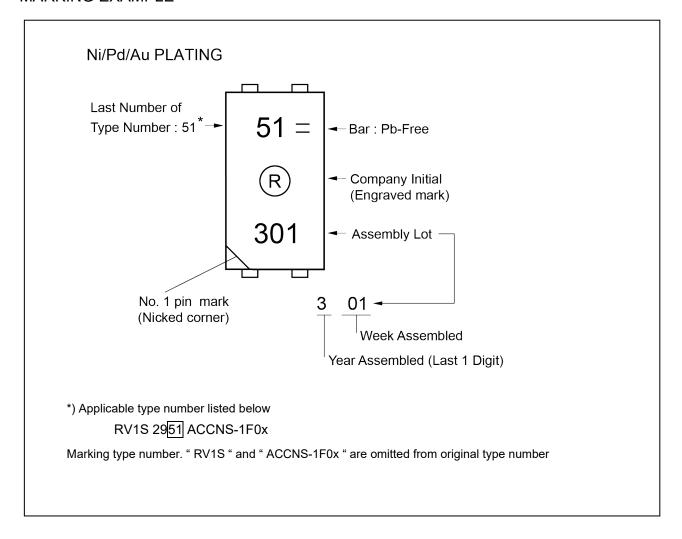


Weight: 0.05 g (TYP.)

## PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	4 mm
Creepage Distance	4 mm
Isolation Distance	0.15 mm

### MARKING EXAMPLE



## ORDERING INFORMATION

Part Number	Order Number	Solder Plating	Packing Style	Safety Standard	Application
		Specification		Approval	Part Number *1
RV1S2951ACCNS	RV1S2951ACCNS	Pb-Free	Embossed Tape	UL, CSA Approved	RV1S2951A
-1F0C	-1F0C#SC0	(Ni/Pd/Au)	50 pcs		
	RV1S2951ACCNS		Embossed Tape		
	-1F0C#KC0		3 500 pcs/reel		
RV1S2951ACCNS	RV1S2951ACCNS		Embossed Tape	UL, CSA, VDE	
-1F0V	-1F0V#SC0		50 pcs	Approved	
	RV1S2951ACCNS		Embossed Tape		
	-1F0V#KC0		3 500 pcs/reel		

Notes: \*1. For the application of the safety standard, the following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C , unless otherwise specified)

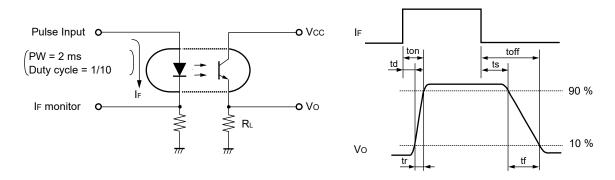
Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	l <sub>F</sub>	2.5	mA
	Reverse Voltage	$V_R$	5	V
	Power Dissipation	$P_D$	3.5	mW
	Peak Forward Current *1	I <sub>FP</sub>	1.0	Α
Transistor	Collector to Emitter Voltage	$V_{CEO}$	40	V
	Emitter to Collector Voltage	V <sub>ECO</sub>	6	V
	Collector Current	lc	80	mA
	Power Dissipation Derating *2	ΔPc/°C	1.5	mW/°C
	Power Dissipation	Pc	150	mW
Isolation Vo	Isolation Voltage *3		2 500	Vr.m.s.
Operating Ambient Temperature		T <sub>A</sub>	-40 to +115	°C
Storage Temperature		T <sub>stg</sub>	-40 to +125	°C

Notes: \*1. PW = 100  $\mu$ s, duty cycle = 1 %.

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I <sub>F</sub> = 0.1 mA	1.22	1.37	1.52	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V			10	μA
	Input Capacitance	Ct	V = 0 V, f = 1 MHz		30		рF
Transistor	Collector to Emitter Dark Current	I <sub>CEO</sub>	$I_F = 0 \text{ mA}, V_{CE} = 40 \text{ V}$			50	nA
Coupled	Current Transfer Ratio	CTR1	$I_F = 50 \mu A, V_{CE} = 5 V$	300		800	%
	$(I_{C}/I_{F})$	CTR2	$I_F = 1 \text{ mA}, V_{CE} = 5 \text{ V}$	300		800	%
	Collector Saturation Voltage	V <sub>CE (sat)</sub>	$I_F = 0.1 \text{ mA}, I_C = 0.2 \text{ mA}$			0.3	٧
	Isolation Resistance	R <sub>I-O</sub>	$V_{I-O} = 1kV_{DC}$	10 <sup>11</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time *1	t <sub>r</sub>	$V_{CC} = 5 \text{ V}, I_F = 0.1 \text{ mA},$		115		μs
	Fall Time *1	t <sub>f</sub>	$R_L = 51 \text{ k}\Omega$		1 150		
	Turn-on Time *1	t <sub>on</sub>			130		
	Turn-off Time *1	t <sub>off</sub>			1 300	-	
	Rise Time *1	tr	$V_{CC} = 5 \text{ V}, I_{C} = 2 \text{ mA},$		5		μs
	Fall Time *1	t <sub>f</sub>	R <sub>L</sub> = 100 Ω		6	-	

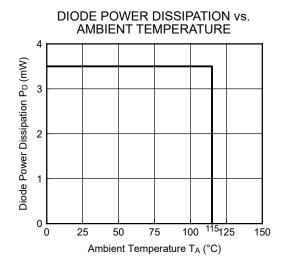
Notes: \*1. Test circuit for switching time

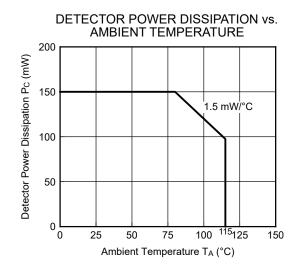


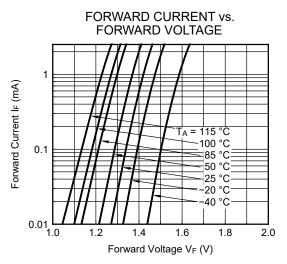
<sup>\*2.</sup> Reduced at a rate of 1.5 mW/°C above  $T_A$  = 80 °C.

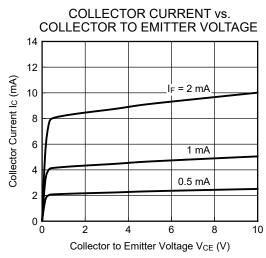
<sup>\*3.</sup> AC voltage for 1 minute at  $T_A$  = 25 °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-4 shorted together.

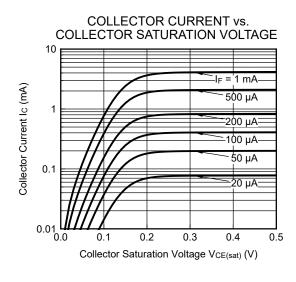
## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise specified)

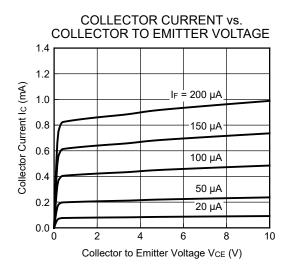






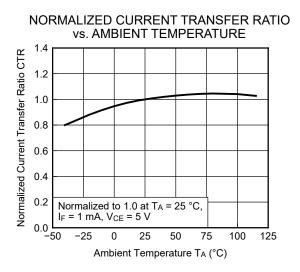


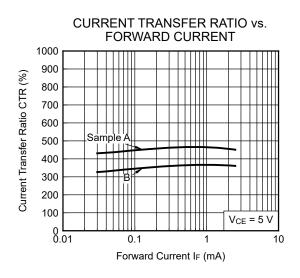


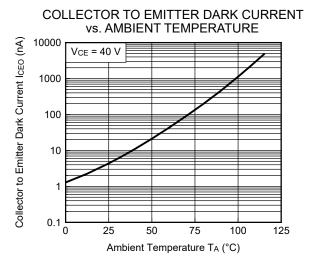


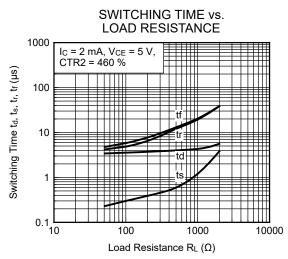
Remark The graphs indicate nominal characteristics.

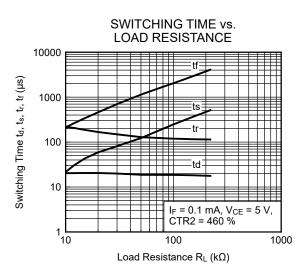
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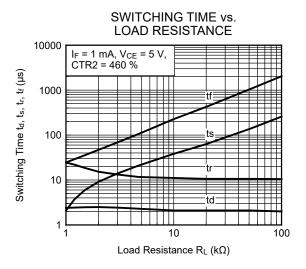






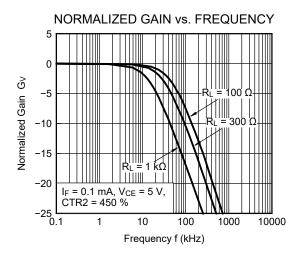


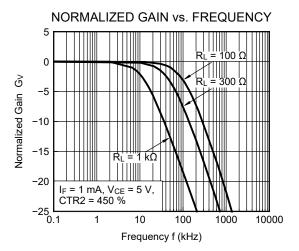




Remark The graphs indicate nominal characteristics.

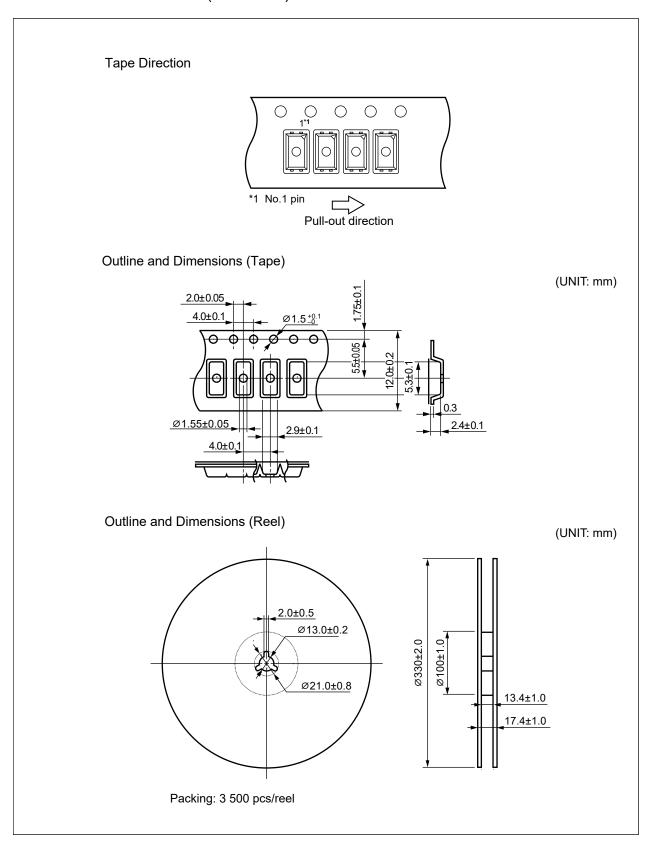
# TYPICAL CHARACTERISTICS ( $T_A$ = 25 °C, unless otherwise specified)



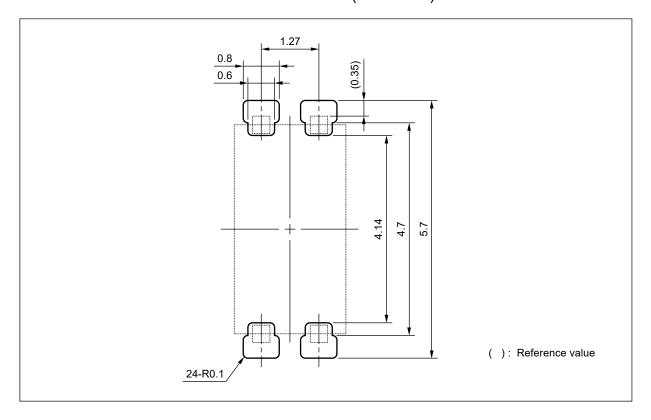


Remark The graphs indicate nominal characteristics.

## TAPING SPECIFICATIONS (UNIT: mm)



# RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark This drawing is considered to meet air and outer creepage distance 4.0 mm minimum.

All dimensions in this figure must be evaluated before use.

### NOTES ON HANDLING

#### 1. Recommended soldering conditions

(1) Infrared reflow soldering

· Peak reflow temperature

• Time of peak reflow temperature -5 °C (255 °C)

Time of temperature higher than 217 °C

Time to preheat temperature from 150 to 200 °C

· Number of reflows

Flux

260 °C or below (package surface temperature)

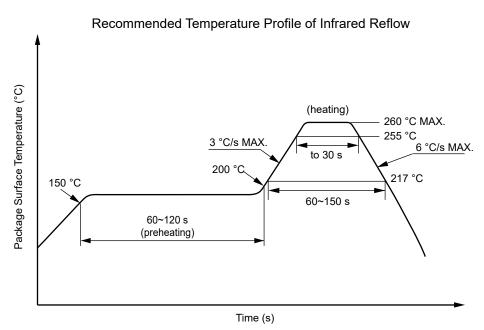
30 seconds or less

60 to 150 seconds

60 to 120 seconds

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)



JEDEC J-STD-020E compliant soldering conditions

## (2) Wave soldering

• Temperature 260 °C or below (molten solder temperature)

Time 10 seconds or less

Preheating conditions 120 °C or below (package surface temperature)

Number of times
 One (Allowed to be dipped in solder including plastic mold portion.)

Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

### (3) Cautions

Flux cleaning
 Fixing/Coating
 Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
 Do not use fixing agents or coatings containing halogen-based substances.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

### **RV1S2951A Data Sheet**

Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations of the like into consideration before use.

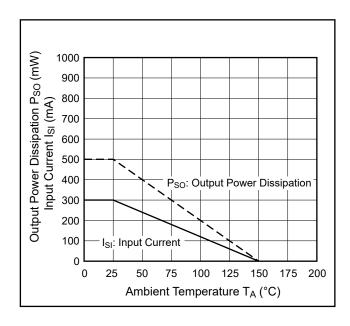
## **USAGE CAUTIONS**

- 1. Product against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

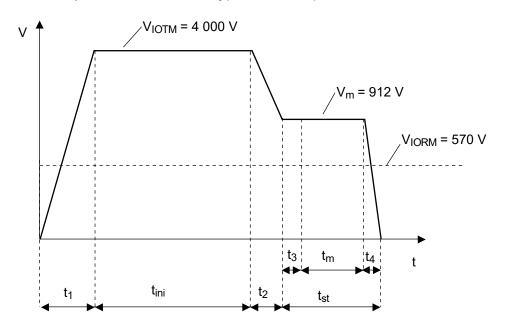
## SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/115/21	
Dielectric strength			
maximum operating isolation voltage	$V_{IORM}$	570	$V_{peak}$
Test voltage (partial discharge test, procedure a for type test and random	$V_{m}$	912	$V_{peak}$
test)			
$V_m = 1.6 \times V_{IORM.}, q_{pd} < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	Vm	1 069	$V_{peak}$
$V_m = 1.875 \times V_{IORM.}$ , $q_{pd} < 5 pC$	V m	1 003	v peak
Highest permissible overvoltage	V <sub>IОТМ</sub>	4 000	$V_{peak}$
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	$T_{stg}$	-40 to +125	°C
Operating temperature range	T <sub>A</sub>	-40 to +115	°C
Isolation resistance, minimum value			
V <sub>I-O</sub> = 500 V dc, T <sub>A</sub> = 25 °C	R <sub>I-O</sub> MIN.	10 <sup>12</sup>	Ω
V <sub>I-O</sub> = 500 V dc, T <sub>A</sub> = maximum temperature of rating, at least 100 °C	R <sub>I-O</sub> MIN.	10 <sup>11</sup>	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Maximum ambient temperature	Ts	150	°C
Maximum input current	I <sub>SI</sub>	300	mA
Maximum output power dissipation	Pso	500	mW
Isolation resistance, minimum value at V <sub>I-O</sub> = 500 V dc, T <sub>A</sub> = T <sub>S</sub>	R <sub>I-O</sub> MIN.	10 <sup>9</sup>	Ω

# Dependence of maximum safety ratings on ambient temperature



# Method a) Destructive Test, Type and Sample Test



 $t_1$ ,  $t_2$  = 1 to 10 sec

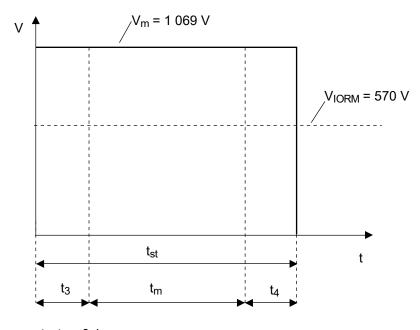
 $t_3$ ,  $t_4 = 1 \sec$ 

 $t_m = 10 sec$ 

 $t_{st}$  = 12 sec

 $t_{ini}$  = 60 sec

## Method b) Non-destructive Test, 100% Production Test



 $t_3$ ,  $t_4 = 0.1 sec$ 

 $t_m = 1.0 \text{ sec}$ 

 $t_{st}$  = 1.2 sec

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• Do not lick the product or in any way allow it to enter the mouth.

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